

International Application No.: PCT/JP2004/008753  
U.S. Patent Application No.: Unknown  
March 8, 2005  
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**IN THE ABSTRACT:**

Please replace the Abstract of the Disclosure originally filed with the above-identified patent application with the following Abstract:

## ABSTRACT OF THE DISCLOSURE

~~The~~A laminated coil is constructed such that an inner space of each via hole can be increased while the spacing between ~~neighboring~~adjacent via holes in the axial direction of a coil is prevented from being narrowed. In the via holes ~~(3)~~ of a~~the~~ laminated coil ~~(1)~~, through-holes ~~(5)~~ formed in ceramic layers ~~(16)~~ and filled with a conductor lie~~are~~ arranged in a row in the lamination direction X, and, in each of the through-holes ~~(5)~~, the difference between the diameter in the axial direction of the coil ~~(4)~~ on the opening surface of one opening ~~(5a)~~ of a ceramic layer ~~(16)~~ and the diameter in the axial direction of the coil ~~(4)~~ on the opening surface of the other opening ~~(5b)~~ is smaller than the difference between the diameter in the direction Z that is substantially perpendicular to the axial direction Y of the coil ~~(4)~~ on the opening surface of one opening ~~(5a)~~ of the ceramic layer ~~(16)~~ and the diameter in the direction Z that is substantially perpendicular to the axial direction Y of the coil ~~(4)~~ on the opening surface of the other opening ~~(5b)~~.